

/ Descriptions

PDFN5×6 N
N-Channel MOSFET in a PDFN5×6 Plastic Package.

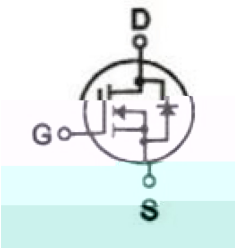
/ Features

Low $R_{DS(ON)}$ to minimize conductive loss;low Gate Charge for fast switching;Low Thermal resistance;HF Product.

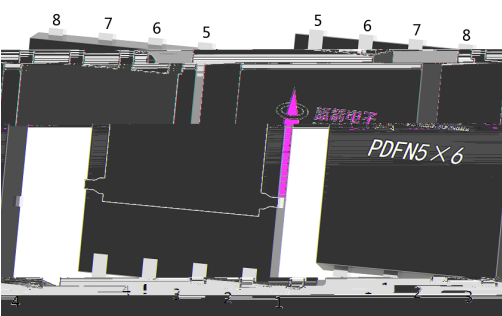
/ Applications

MB/NB/UMPC/VGA Buck -
Battery Management,High Frequency Point-of-Load Synchronous Buck Converter for MB/NB/UMPC/VGA,Networking DC-DC Power System,Load Switch.

/ Equivalent Circuit



/ Pinning



PIN1 2 3 S PIN4 G PIN5 6 7 8 D

Pin	极性
1	S
2	S
3	S
4	G
5	D
6	D
7	D
8	D

/ Marking

See Marking Instructions.

/ Absolute Maximum Ratings($T_a=25$)

Parameter		Symbol	Rating	Unit
Drain-Source Voltage		V _{DS}	40	V
Drain Current - Continuous		I _D	100	A
Drain Current – Pulsed		I _{DM}	285	A
Gate-Source Voltage		V _{GS}	± 20	V
Power Dissipation		P _D (T _c =25)	78	W
Single Pulse Avalanche Energy(L=0.5mH)		E _{AS}	220	mJ
Avalanche Current(L=0.5mH)		I _{AS}	33.2	A
Junction and Storage Temperature Range		T _j , T _{stg}	-55 to 150	
Thermal resistance, junction - ambient	t ≤ 10s	R _{θ JA}	20	/ W
	Steady-State		50	
Thermal resistance, junction - case	Steady-State	R _{θ JC}	1.6	

/ Electrical Characteristics($T_a=25$)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	BV_{DSS}	$I_D=250\mu A, V_{GS}=0V$	40	44		V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=40V, V_{GS}=0V$			1	μA
Gate-Body leakage current	I_{GSS}	$V_{DS}=0V, V_{GS}=\pm 20V$			± 100	nA
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	1.5	1.7	3.0	V
Static Drain-Source On-Resistance	$R_{DS(ON)}$	$V_{GS}=10V, I_D=20A$		1.8	2.0	m Ω
		$V_{GS}=4.5V, I_D=10A$		2.4	4.0	
Diode Forward Voltage	V_{SD}	$I_S=1A, V_{GS}=0V$			1.2	V
Input Capacitance	C_{iss}	$V_{DS}=25V, V_{GS}=0V, f=1.0MHz$		10850		pF
Output Capacitance	C_{oss}			830		
Reverse Transfer Capacitance	C_{rss}			750		
Gate resistance	R_g	$V_{GS}=0V, V_{DS}=0V, f=1MHz$		1.5		Ω
Total Gate Charge	$Q_{g(10V)}$	$V_{GS}=10V, I_D=20A, V_{DS}=20V$		50		nC
Total Gate Charge	$Q_{g(4.5V)}$			22		
Gate Source Charge	Q_{gs}			11.5		
Gate Drain Charge	Q_{gd}			4		

/ Electrical Characteristics(Ta=25)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Turn-On Delay Time	t _{d(on)}	V _{GS} =10V V _{DS} =20V R _L =1.0Ω R _{GEN} =3Ω		11		ns
Turn-On Rise Time	t _r			3.5		
Turn-Off Delay Time	t _{d(off)}			36		
Turn-Off Fall Time	t _f			3		

/ Electrical Characteristic Curve

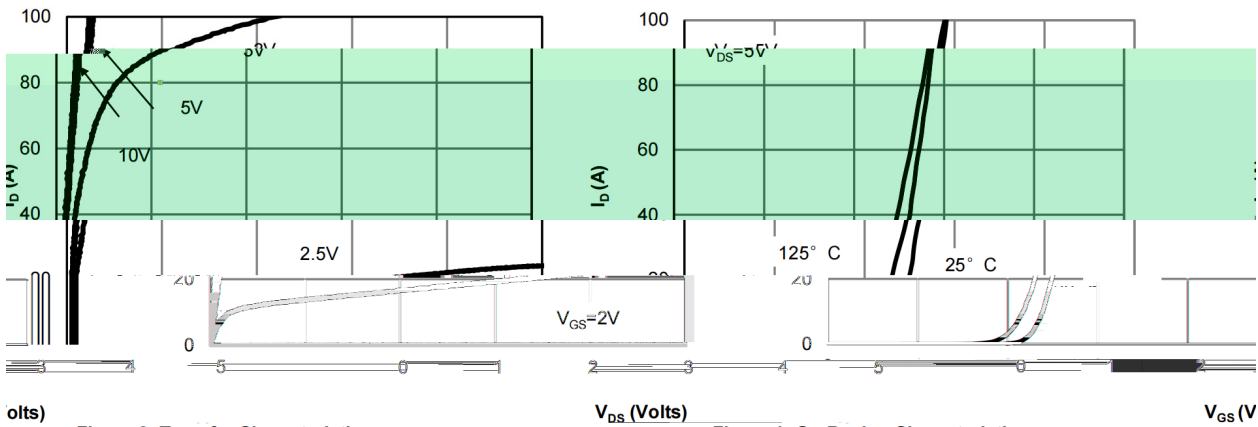


Figure 2: Transfer Characteristics

Figure 1: On-Region Characteristics

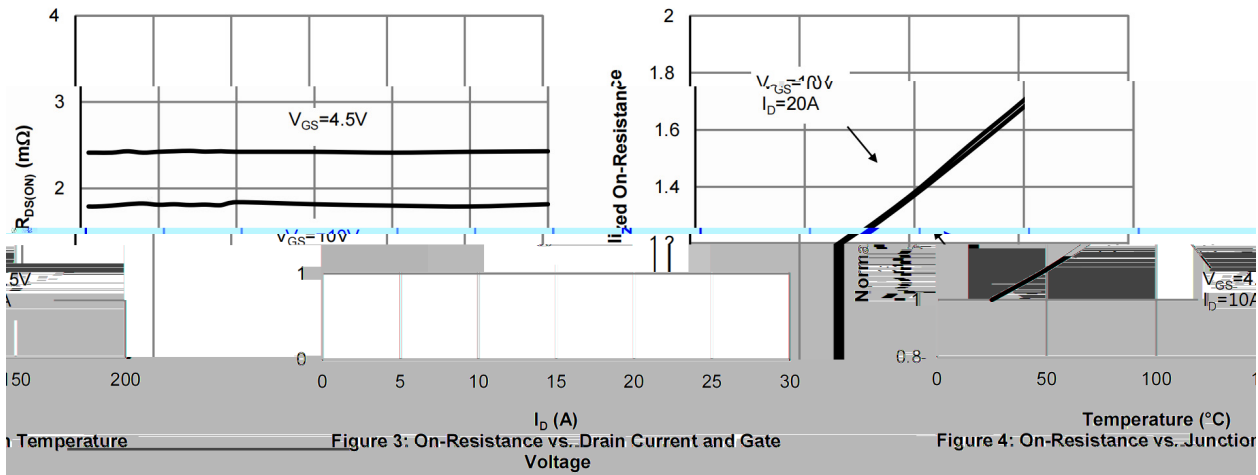


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

Figure 4: On-Resistance vs. Junction Temperature

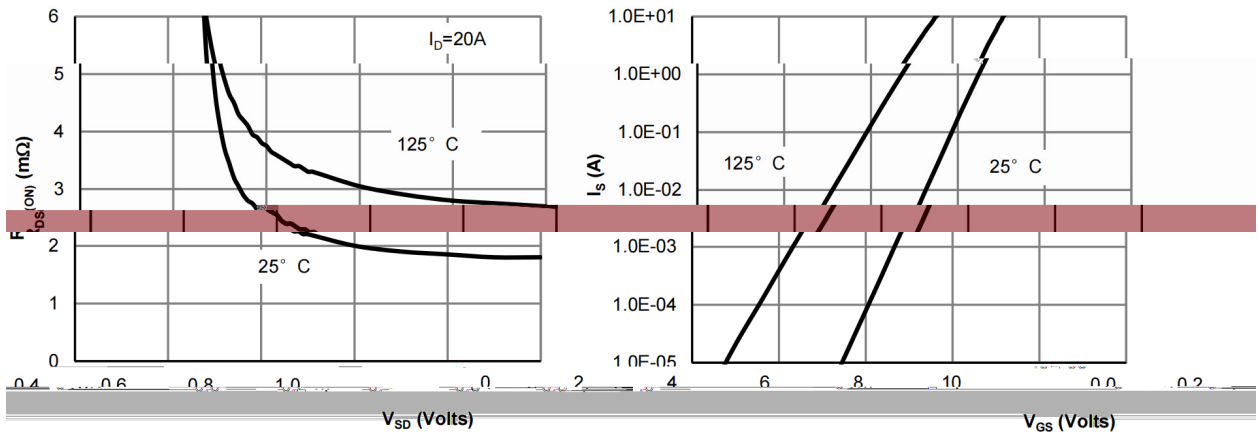


Figure 6: Body Diode Characteristics

Figure 5: On-Resistance vs. Gate-Source Voltage

/ Electrical Characteristic Curve

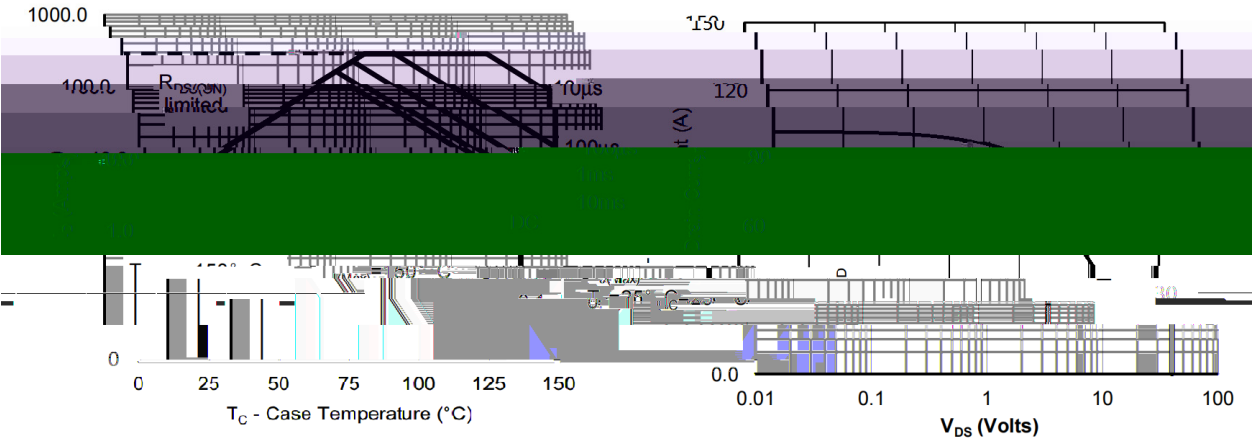
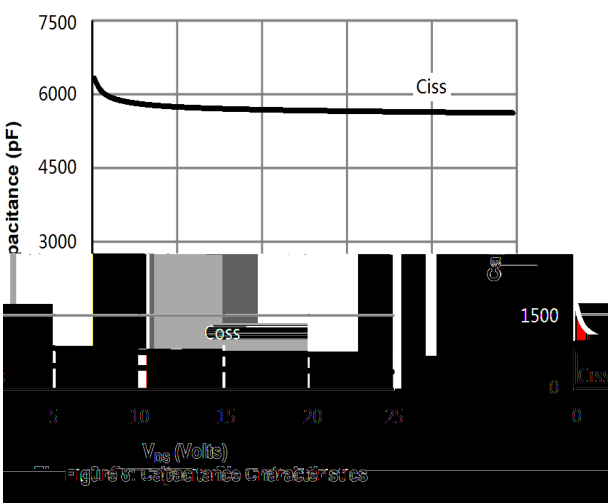
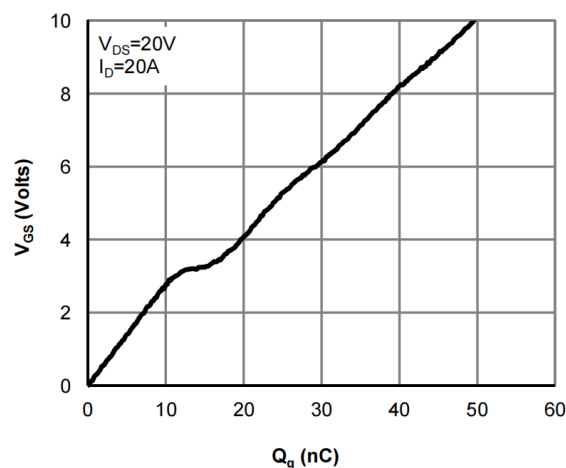
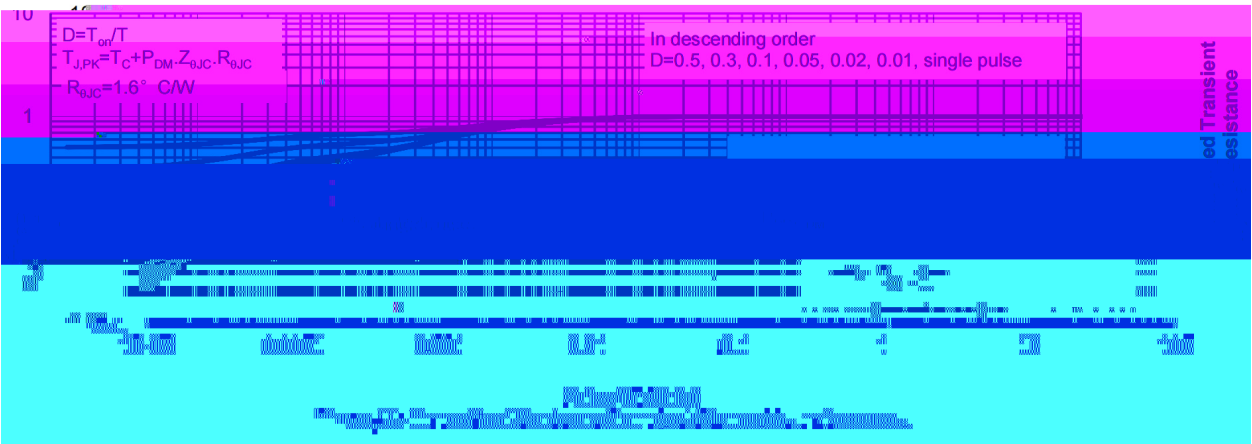


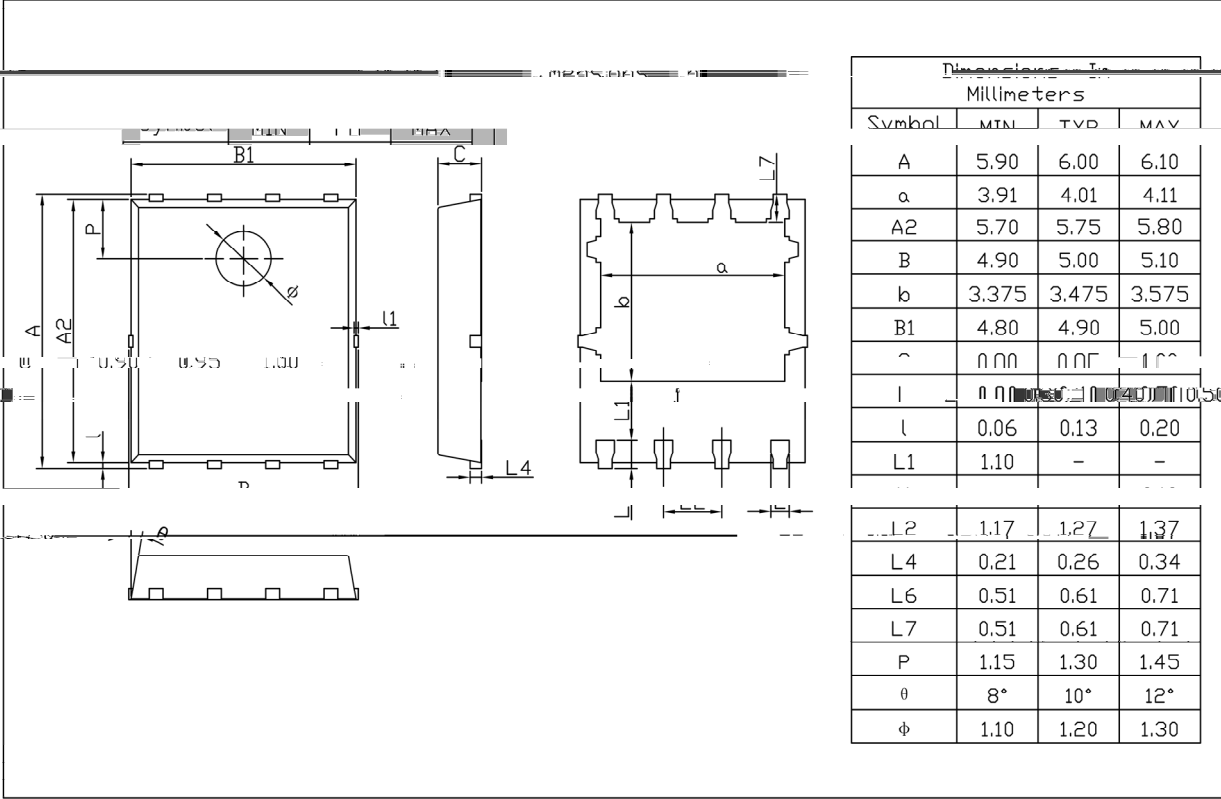
Figure 10: Maximum Continuous Drain Current vs Case Temperature



/ Package Dimensions

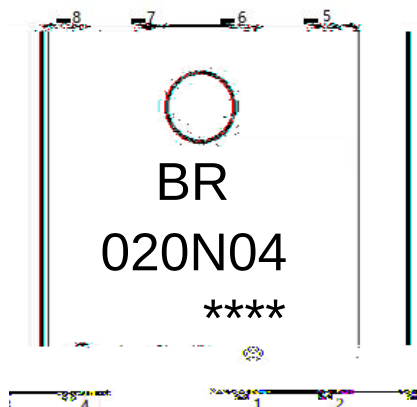
PDFN5 X6

Unit:mm



Rev.01 202209

/ Marking Instructions



BR

020N04

Note

BR

Company Code

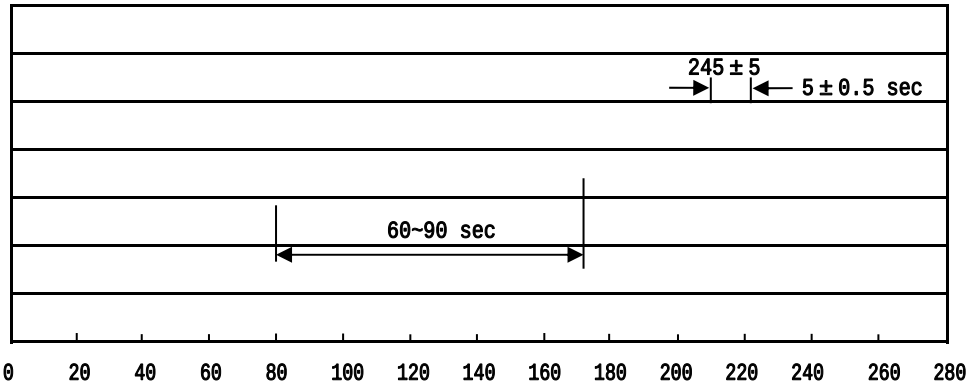
020N04

Product Type Code

****:

Lot No. Code, code change with Lot No

() / **Temperature Profile for IR Reflow Soldering(Pb-Free)**



Note:

- 1

150 180

60 90sec;

1.Preheating:150~180 , Time:60~90sec.
- 2

245±5

5±0.5sec;

2.Peak Temp.:245±5 , Duration:5±0.5sec.
- 3

2 10

/sec.

3. Cooling Speed: 2~10 /sec.

/ **Resistance to Soldering Heat Test Conditions**

260±5 10±1 sec. Temp.:260±5 Time:10±1 sec

/ **Packaging SPEC.**

/ REEL

Package Type	Units					Dimension (unit mm ³)		
	Units/Reel /	Reels/Inner Box /	Units/Inner Box /	Inner Boxes/Outer Box /	Units/Outer Box /	Reel	Inner Box	Outer Box
PDFN5×6	5,000	2	10,000	6	60,000	13"×12	360×360×50	380×335×366

/ **Notices**